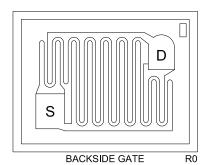


CP216-2N4392

N-Channel JFET Die

The CP216-2N4392 is a silicon N-Channel small signal JFET designed for analog switching and chopper applications.



MECHANICAL SPECIFICATIONS:

Die Size	21 x 16 MILS
Die Thickness	7.9 MILS
Drain Bonding Pad Size	3.3 x 4.5 MILS
Source Bonding Pad Size	3.3 x 4.5 MILS
Top Side Metalization	Al – 10,000Å
Back Side Metalization	Au – 3,250Å
Scribe Alley Width	2.0 MILS
Wafer Diameter	4 INCHES
Gross Die Per Wafer	29,732

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Gate-Drain Voltage	$V_{\sf GD}$	40	V
Gate-Source Voltage	V_{GS}	40	V
Gate Current	I_{G}	50	mA
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +175	°C

ELECTRICAL	CHARACTERISTICS:	$(T_A=25^\circ$	°C unless	otherwise	noted)
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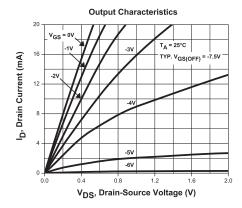
TEST CONDITIONS	MIN	MAX	UNITS
V _{GS} =20V		0.1	nA
V _{DS} =20V	25	75	mA
V_{DS} =20V, V_{GS} =7.0V		0.1	nA
I _G =1.0μA	40		V
V_{DS} =20V, I_D =1.0nA	2.0	5.0	V
$V_{DS}=0$, $I_{G}=1.0$ mA		1.0	V
I _D =6.0mA		0.4	V
I _D =1.0mA, V _{GS} =0		60	Ω
V_{GS} =7.0V, V_{DS} =0, f=1.0MHz		3.5	pF
V_{DS} =20V, V_{GS} =0, f=1.0MHz		20	pF
$I_{D(ON)}=6.0$ mA		15	ns
V _{GS(OFF)} =7.0V		35	ns
	TEST CONDITIONS $V_{GS}=20V$ $V_{DS}=20V$ $V_{DS}=20V$, $V_{GS}=7.0V$ $I_{G}=1.0\mu A$ $V_{DS}=20V$, $I_{D}=1.0nA$ $V_{DS}=0$, $I_{G}=1.0mA$ $I_{D}=6.0mA$ $I_{D}=1.0mA$, $V_{GS}=0$ $V_{GS}=7.0V$, $V_{DS}=0$, $f=1.0MHz$ $V_{DS}=20V$, $V_{GS}=0$, $f=1.0MHz$ $I_{D}(ON)=6.0mA$	$\begin{array}{lll} \text{TEST CONDITIONS} & \text{MIN} \\ V_{GS} = 20V & 25 \\ V_{DS} = 20V, \ V_{GS} = 7.0V \\ I_{G} = 1.0 \mu A & 40 \\ V_{DS} = 20V, \ I_{D} = 1.0 n A & 2.0 \\ V_{DS} = 0, \ I_{G} = 1.0 m A & \\ I_{D} = 6.0 m A & \\ I_{D} = 1.0 m A, \ V_{GS} = 0 & \\ V_{GS} = 7.0V, \ V_{DS} = 0, \ f = 1.0 M Hz \\ V_{DS} = 20V, \ V_{GS} = 0, \ f = 1.0 M Hz \\ I_{D}(ON) = 6.0 m A & \\ \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

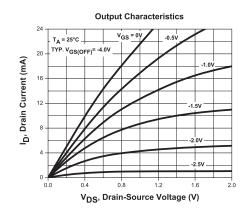
CP216-2N4392

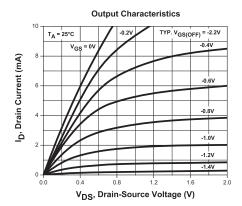
Typical Electrical Characteristics

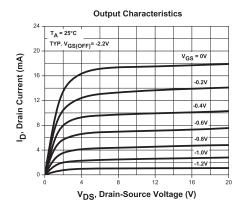


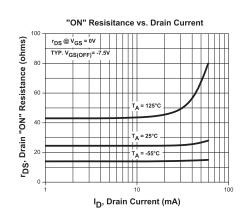
www.centralsemi.com

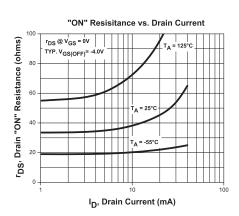








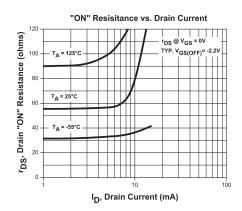


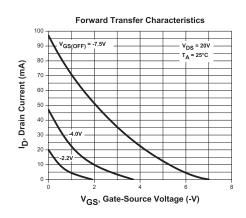


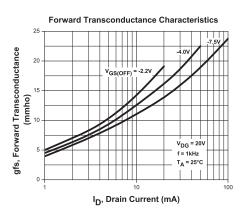
CP216-2N4392

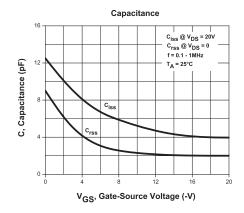
Typical Electrical Characteristics

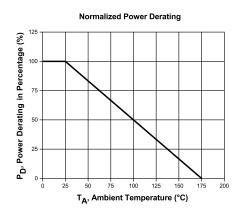








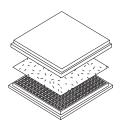




R2 (28-August 2020)

BARE DIE PACKING OPTIONS

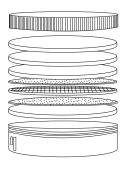




BARE DIE IN TRAY (WAFFLE) PACK

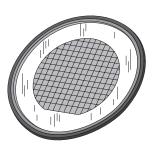
CT: Singulated die in tray (waffle) pack. (example: CP211-PART NUMBER-CT)

CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-PART NUMBER-CM)



UNSAWN WAFER

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



SAWN WAFER ON PLASTIC RING

WR: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked.

(example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

R2 (3-April 2017)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA

Main Tel: (631) 435-1110 Main Fax: (631) 435-1824

Support Team Fax: (631) 435-3388

www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

Worldwide Distributors:

www.centralsemi.com/wwdistributors

For the latest version of Central Semiconductor's **LIMITATIONS AND DAMAGES DISCLAIMER**, which is part of Central's Standard Terms and Conditions of sale, visit: www.centralsemi.com/terms

www.centralsemi.com (001)



Product End of Life Notification

PDN ID:	PDN01171
Notification Date:	4/01/21
Last Buy Date:	Stock Only
Last Shipment Date	Stock Only

Please be advised that Central Semiconductor must immediately discontinue the product(s) listed in the attached PDN notice.

Orders can only be accepted for products with available inventory on hand.

You may have purchased one or more of the products listed. Please do not hesitate to contact your local Central Semiconductor sales representative with any questions or needs you may have. Central regrets any inconvenience this may cause.

Sincerely,

Central Semiconductor Corp.

DISCLAIMER: This End of Life (EOL) notification is in accordance with JEDEC standard JESD48 - Product Discontinuance. Central Semiconductor Corp. will make every effort to offer life-time buy (LTB) opportunities and/or offer replacement devices to existing customers for discontinued devices, however, one or both may not be possible for all devices. Please contact your local Central Semiconductor sales representative for LTB opportunities/additional information.

CCC785 REV 002



Product End of Life Notification

PDN ID:	PDN01171
Notification Date:	4/01/21
Last Buy Date:	
Last Shipment Date	Stock Only

Summary: The CP216 wafer process is being discontinued and is now classified as End of Life (EOL). Replacement wafer process CP226V was previously announced in PCN202, January 28, 2021.

Although Central Semiconductor Corp. makes every effort to continue to produce devices that have been proclaimed EOL (End of Life) by other manufacturers, it is an accepted industry practice to discontinue certain devices when customer demand falls below a minimum level of sustainability. Accordingly, the following product(s) have been transitioned to End of Life status as part of Central's ongoing Product Management Process. Any replacement products are noted below. The effective date for placing last purchase orders will be six (6) months from the date of this notice and twelve (12) months from the notice date for final shipments, and minimum order quantities may apply. The last purchase and shipment dates may be extended if inventory is available.

* All Plating types (PBFREE,TIN/LEAD) for each item listed are included in this notice.

Central Part Number	Replacement
CP216-2N4392-CT	CP226V-2N4392-CT
CP216-2N4392-CT20	CP226V-2N4392-CT20
CP216-2N4393-CT	CP226V-2N4393-CT
CP216-2N4393-CT20	CP226V-2N4393-CT20

Central would be happy to assist you by providing additional information or technical data to help locate an alternate source if we have no replacement available. Please email your requests to engineering@centralsemi.com.

DISCLAIMER: This End of Life (EOL) notification is in accordance with JEDEC standard JESD48 - Product Discontinuance. Central Semiconductor Corp. will make every effort to offer life-time buy (LTB) opportunities and/or offer replacement devices to existing customers for discontinued devices, however, one or both may not be possible for all devices. Please contact your local Central Semiconductor sales representative for LTB opportunities/additional information.

CCC785 REV 002